

< C band internally matched power GaAs FET >

MGFC36V5258

5.2 - 5.8 GHz BAND / 4W

DESCRIPTION

The MGFC36V5258 is an internally impedance-matched GaAs power FET especially designed for use in 5.2-5.8 GHz band amplifiers. The hermetically sealed metal-ceramic package guarantees high reliability.

FEATURES

Internally matched to 50(ohm) system

- High output power
 - P1dB=4W (TYP.) @f=5.2 5.8GHz
- High power gain GLP=10.0dB (TYP.) @f=5.2 – 5.8GHz
- High power added efficiency
 P.A.E.=32% (TYP.) @f=5.2 5.8GHz

APPLICATION

• 5.2 – 5.8 GHz band microwave high power amplifier

QUALITY

• IG

RECOMMENDED BIAS CONDITIONS

• VDS=10V • ID=1.2A • RG=100ohm Refer to Bias Procedure

Absolute maximum ratings (Ta=25°C)

Symbol	Parameter	Ratings	Unit						
VGDO	Gate to drain breakdown voltage	-15	V						
VGSO	Gate to source breakdown voltage	-15	V						
ID	Drain current	2.8	Α						
IGR	Reverse gate current	-10	mA						
IGF	Forward gate current	21	mA						
PT *1	Total power dissipation	25	W						
Tch	Cannel temperature	175	ç						
Tstg	Storage temperature	-65 to +175	°C						
*4 · T- 0000									

^{*1 :} Tc=25°C

Electrical characteristics (Ta=25°C)

Symbol	Parameter	Test conditions	Limits			Unit
			Min.	Тур.	Max.	
IDSS	Saturated drain current	VDS=3V, VGS=0V	-	2.0	2.8	А
gm	Trans conductance	VDS=3V, ID=1.1A	-	2	-	S
VGS(off)	Gate to source cut-off voltage	VDS=3V,ID=10mA	-2	-3	-4	V
P1dB	Output power at 1dB gain compression	VDS=10V,ID(RF off)=1.2A	35	36	-	dBm
GLP *2	Linear Power Gain	f=5.2 – 5.8GHz	9	10	-	dB
P.A.E.	Power added efficiency	Pin=20dBm *2	-	32	-	%
ID	Drain current	1	-	1.1	1.4	Α
Rth(ch-c) *3	Thermal resistance	delta Vf method	-	5	6	°C/W

^{*3 :}Channel-case

OUTLINE DRAWING Unit : millimeters

21.0 ± 0.3

(1) 0.6 ± 0.15

(2) R.1.6

(3) 10.7

17.0 ± 0.2

(1) GATE
(2) SOURCE (FLANGE)
(3) DRAIN

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CSTG-16270

Publication Date: Dec., 2014